查询ι<mark>ος Αικί</mark>Α Ενδικ<mark>κάσε</mark> FET Module Silicon N Channel MOS Type (Four L²-π-MOSV in One)

MP4410

High Power, High Speed Switching Applications Hammer Drive, Pulse Motor Drive and Inductive Load Switching

• 4-V gate drivability

• Small package by full molding (SIP 12 pin)

• High drain power dissipation (4-device operation)

 $: P_T = 28 \text{ W (Tc} = 25^{\circ}\text{C)}$

• Low drain-source ON resistance: RDS (ON) = 0.12Ω (typ.)

• Low leakage current: $I_{GSS} = \pm 10 \mu A \text{ (max) (V}_{GS} = \pm 16 \text{ V)}$

 $I_{DSS} = 100 \, \mu A \, (max) \, (V_{DS} = 60 \, V)$

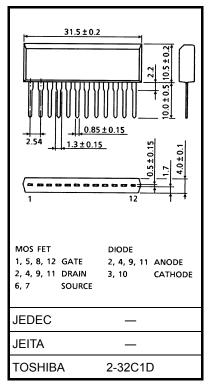
• Enhancement-mode: $V_{th} = 0.8 \text{ to } 2.0 \text{ V (Ip} = 1 \text{ mA)}$

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	60	V	
Gate-source voltage		V _{GSS}	±20	V	
Drain current		ΙD	5	Α	
Peak drain current		I _{DP}	20	Α	
Drain power dissipation (1-device operation)		P _D	2.2	W	
Drain power dissipation (4-device operation)	Ta = 25°C	Рт	4.4	W	
	Tc = 25°C	F1	28	VV	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	−55 to 150	°C	

Industrial Applications

Unit: mm

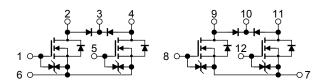


Weight: 3.9 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

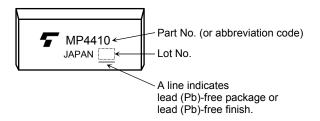
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Array Configuration





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Thermal Characteristics

Characteristics	Symbol	Max	Unit	
Thermal resistance of channel to ambient	ΣR _{th (ch-a)}	28.4	°C/W	
(4-device operation, Ta = 25°C)	, ,			
Thermal resistance of channel to case	7D	4.46	°C/W	
(4-device operation, Tc = 25°C)	ΣR _{th (ch-c)}	4.40	C/VV	
Maximum lead temperature for soldering purposes	TL	260	°C	
(3.2 mm from case for 10 s)				

This transistor is an electrostatic-sensitive device. Please handle with caution.

Electrical Characteristics (Ta = 25°C)

Chara	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V	_	_	±10	μΑ
Drain cut-off curre	ent	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V	_	_	100	μΑ
Drain-source brea	akdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	60	_	_	V
Gate threshold vo	oltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	0.8	_	2.0	V
Forward transfer	admittance	Y _{fs}	V _{DS} = 10 V, I _D = 2.5 A	3.0	5.0	_	S
Drain-source ON resistance	_	I _D = 2.5 A, V _{GS} = 4 V	_	0.21	0.31	Ω	
	R _{DS} (ON)	I _D = 2.5 A, V _{GS} = 10 V	_	0.12	0.16		
Input capacitance	9	C _{iss}		ı	370	_	pF
Reverse transfer capacitance		C _{rss} V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	60	_	pF	
Output capacitance		Coss		_	180	_	pF
Switching time Fall time	Rise time	t _r	$I_{D} = 2.5 \text{ A}$ 10 V 0 V 10 µs $V_{DD} \approx 30 \text{ V}$ $V_{IN}: t_{r}, t_{f} < 5 \text{ ns, dutys cycle} \le 1\%$	-	18	_	
	Turn-on time	t _{on}		1	25	_	ne
	Fall time	t _f		-	15	_	ns
	Turn-off time	t _{off}			170	_	
Total gate charge (gate-source plus gate-drain)		Qg	I _D = 5 A, V _{GS} = 10 V, V _{DD} = 48 V	-	12	_	nC
Gate-source charge		Q _{gs}		_	8	_	nC
Gate-drain ("miller") charge		Q _{gd}		_	4	_	nC

<u>รอนาเลย Drain Diode Ra</u>ting and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current	I_{DR}	_	_	_	5	Α
Peak drain reverse current	I _{DRP}	_	_	_	20	Α
Diode forward voltage	V_{DSF}	I _{DR} = 5 A, V _{GS} = 0 V	_		-1.7	V

Flyback-Diode Rating and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Maximum forward current	I _{FM}	_	_	_	5	Α
Reverse current	I _R	V _R = 120 V	_	_	0.4	μΑ
Reverse voltage	V_{R}	I _R = 100 μA	120	_	_	V
Forward voltage	V _F	I _F = 1 A		_	1.8	V

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